

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4197872

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST	
CONVEYING PARTY DATA		
Name		Execution Date
MORGAN STANLEY SENIOR FUNDING, INC.		12/09/2016
RECEIVING PARTY DATA		
Name:	CYPRESS SEMICONDUCTOR CORPORATION	
Street Address:	198 CHAMPION COURT	
City:	SAN JOSE	
State/Country:	CALIFORNIA	
Postal Code:	95134	
Name:	SPANSION LLC	
Street Address:	198 CHAMPION COURT	
City:	SAN JOSE	
State/Country:	CALIFORNIA	
Postal Code:	95134	
PROPERTY NUMBERS Total: 78		
Property Type	Number	
Application Number:	08970520	
Application Number:	08993149	
Application Number:	09353781	
Application Number:	09465724	
Application Number:	09502163	
Application Number:	09504087	
Application Number:	09533057	
Application Number:	09535255	
Application Number:	09538168	
Application Number:	09539307	
Application Number:	09548616	
Application Number:	09563024	
Application Number:	09586254	
Application Number:	09588119	
Application Number:	09627584	

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Property Type	Number
Application Number:	09651684
Application Number:	09663121
Application Number:	09665916
Application Number:	09667686
Application Number:	09681314
Application Number:	09685968
Application Number:	09685972
Application Number:	09691643
Application Number:	09699531
Application Number:	09703151
Application Number:	09764223
Application Number:	09799469
Application Number:	09805287
Application Number:	09871172
Application Number:	09875073
Application Number:	09884204
Application Number:	10017832
Application Number:	10044510
Application Number:	10045354
Application Number:	10067765
Application Number:	10109526
Application Number:	10112572
Application Number:	10120116
Application Number:	10126841
Application Number:	10165837
Application Number:	10305889
Application Number:	10327094
Application Number:	10358756
Application Number:	10389276
Application Number:	10418174
Application Number:	10799413
Application Number:	10850395
Application Number:	10934923
Application Number:	10993202
Application Number:	11086310
Application Number:	11122123
Application Number:	11138823
Application Number:	11168448

Property Type	Number
Application Number:	11169747
Application Number:	11494620
Application Number:	11540831
Application Number:	11644196
Application Number:	11781551
Application Number:	12006224
Application Number:	12006226
Application Number:	12006227
Application Number:	12043506
Application Number:	12059560
Application Number:	12154584
Application Number:	60148579
Application Number:	60151458
Application Number:	60155551
Application Number:	60169185
Application Number:	60181709
Application Number:	60227121
Application Number:	60233957
Application Number:	60234523
Application Number:	60239467
Application Number:	60598360
Application Number:	60722612
Application Number:	60838694
Application Number:	60909362
Application Number:	60931701

CORRESPONDENCE DATA

Fax Number: (408)545-6911

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: kalk@cypress.com, patents@cypress.com

Correspondent Name: CYPRESS SEMICONDUCTOR CORPORATION

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ATTORNEY DOCKET NUMBER:	DRAKE Q4-2016
NAME OF SUBMITTER:	TIMOTHY R CROLL
SIGNATURE:	/Timothy R. Croll36771/
DATE SIGNED:	12/22/2016

Total Attachments: 6

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PARTIAL RELEASE OF SECURITY INTEREST IN PATENTS

This PARTIAL RELEASE OF SECURITY INTEREST (this "Release") is made and executed by Morgan Stanley Senior Funding, Inc., as collateral agent for the Secured Parties (as defined in the Pledge and Security Agreement referred to below) (the "Collateral Agent"), in favor of Cypress Semiconductor Corporation, a Delaware corporation, and Spansion LLC, a Delaware limited liability company (each a "Grantor" and collectively, the "Grantors"). Capitalized terms used but not defined herein shall have the meanings ascribed to such terms in the Pledge and Security Agreement.

A. Pursuant to that certain Amended and Restated Pledge and Security Agreement, dated March 12, 2015 (as further amended and/or restated, supplemented or otherwise modified from time to time, the "Pledge and Security Agreement"), as security for the prompt and complete payment and performance in full when due (whether at stated maturity, by required prepayment, declaration, acceleration, demand or otherwise, including the payment of amounts that would become due but for the operation of the automatic stay under Section 362(a) of the Bankruptcy Code) of all Secured Obligations, each Grantor pledged and granted to the Collateral Agent, for its benefit and for the benefit of the Secured Parties, a continuing security interest in and Lien of all of its right, title, and interest in, to and under the Collateral.

B. Collateral Agent recorded its security interest with the United States Patent and Trademark Office as follows:

Debtor	Secured Party	Reel/Frame	Recordation Date
Cypress Semiconductor Corporation	Morgan Stanley Senior Funding, Inc.	028863/0870	August 28, 2012
Cypress Semiconductor Corporation	Morgan Stanley Senior Funding, Inc.	031636/0105	November 14, 2013
(1) Cypress Semiconductor Corporation (2) Spansion LLC	Morgan Stanley Senior Funding, Inc.	035240/0429	March 21, 2015

C. Grantors have requested that the Collateral Agent release its continuing security interest in and Lien on all of Cypress Semiconductor's right, title and interest in, to and under the patents, and applications therefor, set forth on Exhibit A (the "Specified IP").

D. The Collateral Agent agrees to release its continuing security interest in and Lien on all of each Grantor's right, title and interest in, to and under the Specified IP.

NOW, THEREFORE, for valuable consideration received, by its execution of this Release, the Collateral Agent hereby irrevocably and unconditionally releases, without representation, warranty or recourse, its continuing security interest in and Lien on all of each Grantor's right, title and interest in, to and under the Specified IP.

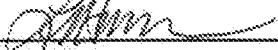
For the avoidance of doubt, the Collateral Agent continues to maintain its continuing security interest in and Lien on all of each Grantor's right, title and interest in, to and under all Collateral other than the Specified IP. The provisions of the Pledge and Security Agreement shall, except as modified by this Release, continue in full force and effect.

This Release is governed by the law of the State of New York, excluding its choice of law principles that would result in the application of any law other than the law of the State of New York. This Release shall be binding upon, and inure to the benefit of, each Grantor and their respective successors and assigns with respect to the Specified IP (including any purchaser thereof).

[Signature page follows]

IN WITNESS WHEREOF, the undersigned has executed this Partial Release of Security Interest
in Patents on this 9th day of December, 2016.

Morgan Stanley Senior Funding, Inc., as Collateral Agent

By: 

Name: Lisa Hume

Title: VP

[Signature page to Partial Release of Security Interest in Patents]

Exhibit A

Specified IP

Item No.	Case No.	Country	App #	Filing Date	Patent Number	Issue Date
1	SIM01002	US	09/681,314	3/16/2001	6512694	1/28/2003
2	PM01006	US	10/112,572	3/29/2002	6979640	12/27/2005
3	RTN97010	US	08/970,520	11/14/1997	6028783	2/22/2000
4	RTN97010C1	US	09/465,724	12/17/1999	6185123	2/6/2001
5	RTN97010C2	US	09/663,121	9/15/2000	6252793	6/26/2001
6	RTN97010C3	US	09/764,223	1/16/2001	6560137	5/6/2003
7	RTN97010C4	US	10/389,276	3/13/2003	6856573	2/15/2005
8	RTN97010C5	US	10/993,202	11/18/2004		
9	SIM07007	US	12/006,224	12/31/2007	7778098	8/17/2010
10	SIM07008	US	12/006,227	12/31/2007	8059458	11/15/2011
11	SIM07008TW	TW	97148136.0	12/11/2008	1489454	6/21/2015
12	SIM07008WO	PCT	PCT/US08/88610	12/31/2008		
13	SPN05063	US	11/086310	3/23/2005	7492001	2/17/2009
14	SPN05063JP	JP	2008-503121	3/22/2006		
15	SPN05063TW	TW	95110020	3/23/2006		
16		PCT	PCT/US06/10362	3/22/2006		
17	PM07018	US	12/154,584	5/22/2008	8269287	9/18/2012
18	PM07018P1	US	60/931,701	5/25/2007		
19	PM07018WO	PCT	PCT/US08/06628	5/23/2008		
20	SPN03026	US	10/358756	2/5/2003	6953752	10/11/2005
21	SPN97062D1	US	09/353781	7/15/1999	6211058	4/3/2001
22	CD04091	US	11/138,823	5/26/2005	7746096	6/29/2010
23	CD04091P1	US	60/598,360	8/3/2004		
24	CD05127	US	11/540,831	9/28/2006	7479800	1/20/2009
25	CD05127P1	US	60/722,612	9/29/2005		
26	CD00063	US	09/703,151	10/30/2000	6469930	10/22/2002
27	PM99027	US	09/871,172	5/31/2001	6556487	4/29/2003
28	PM99027P1	US	60/233,957	9/20/2000		
29	SPN02001D1	US	10/327094	12/24/2002	6765420	7/20/2004
30	SPN02001	US	10/850,395	5/21/2004		
31	SPN02001JP	JP	2002-000668	1/7/2002	4060597	12/28/2007
32	SPN02001JPD1	JP	2007-298902	1/7/2002	4791435	7/29/2011
33	SPN02001TW	TW	091137887	12/30/2002	1280745	5/1/2007
34	SPN02067	US	10/418174	4/18/2003	6788152	9/7/2004
35	SPN02067JP	JP	2002-118233	4/19/2002	4005401	8/31/2007
36	SPN00026	US	09/535255	3/23/2000	6432618	8/13/2002
37		US	60/181,709	2/11/2000		

Item No.	Case No.	Country	App #	Filing Date	Patent Number	Issue Date
38	SPN00031	US	09/502163	2/11/2000	6420752	7/16/2002
39	SPN00031D1	US	10/109526	3/27/2002	6475847	11/5/2002
40	SPN00108	US	09/533057	3/22/2000	6351017	2/26/2002
41	SPN00108D1	US	10/044510	1/11/2002	6514830	2/4/2003
42	SPN00111	US	09/538168	3/30/2000	6346466	2/12/2002
43	SPN00111D1	US	10/067,765	2/8/2002	6548336	4/15/2003
44	SPN00112	US	09/539307	3/30/2000	6448594	9/10/2002
45	SPN00143	US	09/586254	5/31/2000	6294460	9/25/2001
46	SPN00144	US	09/588119	5/31/2000	6380067	4/30/2002
47	SPN00151	US	09/627584	7/28/2000	6376341	4/23/2002
48	SPN00194	US	09/884204	6/19/2001	6573151	6/3/2003
49	SPN00194P1	US	60/227,121	8/22/2000		
50	SPN00203	US	09/651684	8/30/2000	6417082	7/9/2002
51	SPN00214	US	09/665916	9/20/2000	6529410	3/4/2003
52	SPN00215	US	09/805287	3/13/2001	6627526	9/30/2003
53	SPN00215P1	US	60/234,523	9/21/2000		
54	SPN00220	US	09/799469	3/5/2001	6306713	10/23/2001
55	SPN00220P1	US	60/239,467	10/10/2000		
56	SPN00221	US	09/685972	10/10/2000	6482699	11/19/2002
57	SPN00222	US	09/685968	10/10/2000	6271087	8/7/2001
58	SPN00228	US	09/691643	10/18/2000	6537866	3/25/2003
59	SPN00234	US	09/699531	10/30/2000	6500768	12/31/2002
60	SPN01071	US	09/875073	6/5/2001	6509202	1/21/2003
61	SPN01127	US	10/045354	11/7/2001	6809033	10/26/2004
62	SPN01142	US	10/017832	12/12/2001	6731130	5/4/2004
63	SPN02058	US	10/120116	4/9/2002	6806165	10/19/2004
64	SPN02250	US	10/305889	11/26/2002	6798068	9/28/2004
65	SPN02250TW	TW	92123888	8/29/2003	1327338	7/11/2010
66	SPN02250SG	SG	200503037-4	7/10/2003	112466	7/31/2007
67	SPN02250KR	KR	10-2005-7009467	7/10/2003	10-1163681	7/2/2012
68	SPN02250JP	JP	2004-555271	7/10/2003	4708793	3/25/2011
69	SPN02250EP	EP	3811994.7	7/10/2003		
70	SPN02250CN	CN	03825408.5	7/10/2003	3825408.5	3/3/2010
71		AU	AU20030261138	7/10/2003		
72	SPN02250WO	PCT	PCT/US03/21669	7/10/2003		
73	SPN02071	US	10/126841	4/19/2002	6689666	2/10/2004
74	SPN02104	US	10/165837	6/6/2002	6607925	8/19/2003
75	SPN97087C1	US	08/993149	12/18/1997	6228746	5/8/2001
76	SPN99056	US	09/548616	4/13/2000	6534411	3/18/2003
77		US	60/148,579	8/13/1999		
78	SPN99072	US	09/504087	2/15/2000	6682978	1/27/2004

Item No.	Case No.	Country	App #	Filing Date	Patent Number	Issue Date
79		US	60/151,458	8/30/1999		
80	SPN99072TW	TW	89117592	8/30/2000	147966	4/25/2002
81	SPN99072KR	KR	7002796/2002	7/17/2000	724154	5/25/2007
82	SPN99072JP	JP	2001-520470	7/17/2000	4955880	3/23/2012
83	SPN99072GB	GB	948751.3	7/17/2000	1218941	4/2/2014
84	SPN99072FR	FR	948751.3	7/17/2000	1218941	4/2/2014
85	SPN99072EP	EP	948751.3	7/17/2000	1218941	4/2/2014
86	SPN99072DE	DE	60048505.6	7/17/2000	1218941	4/2/2014
87	SPN99072CN	CN	812201.6	7/17/2000	ZL00812201.6	12/29/2004
88		PCT	PCT/US00/19572	7/17/2000		
89	SPN99093	US	09/667686	9/22/2000	6506640	1/14/2003
90		US	60/155,551	9/24/1999		
91	SPN99184	US	09/563024	5/2/2000	6365945	4/2/2002
92		US	60/169,185	12/6/1999		
93	SPN99184TW	TW	90110119	4/27/2001	168219	4/15/2003
94	SPN99184WO	PCT	PCT/US01/13855			
95	SIM06010	US	11/644,196	12/22/2006	7385857	6/10/2008
96	SIM06010P1	US	60/838,694	8/18/2006		
97	SIM07002	US	12/006,226	12/31/2007	8064255	11/22/2011
98	SPN05003	US	11/122123	5/5/2005	7373531	5/13/2008
99	SPN05003TW	TW	94114883	5/9/2005	I311008	6/11/2009
100	SPN05003JP	JP	2005-004532	1/11/2005	4178279	9/5/2008
101	SPN05003EP	EP	5009782.3	5/4/2005		
102	SPN05065	US	11/169747	6/30/2005	8024495	9/20/2011
103	SPN05065JP	JP	2005-085245	3/24/2005	4606216	10/15/2010
104	SPN05072	US	11/168448	6/29/2005	7978750	7/12/2011
105	SPN05072JP	JP	2005-095684	3/29/2005	4342464	7/17/2009
106	SPN06059	US	11/494620	7/28/2006	7315158	1/1/2008
107	SPN06059TW	TW	95127986	7/31/2006	I320264	2/1/2010
108	SPN06059KR	KR	2006-0082065	8/29/2006	10-0732141	6/19/2007
109	SPN06059JP	JP	2006-086372	3/27/2006	4704260	3/18/2011
110	SPN06059EP	EP	6119080.7	8/17/2006		
111	SPN06059CN	CN	200610128810	8/30/2006	101047372	12/2/2009
112	SPN07027	US	12/043506	3/6/2008	8078887	12/13/2011
113	SPN07027JP	JP	2007-055092	3/6/2007	5098367	10/5/2012
114	SPN04035	US	10/799413	3/12/2004	7265014	9/4/2007
115	SPN04035D1	US	11/781,551	7/23/2007		
116	SPN04156	US	10/934923	9/2/2004	7361587	4/22/2008
117	CD06227	US	12/059,560	3/31/2008	7859906	12/28/2010
118	CD06227P1	US	60/909,362	3/30/2007		